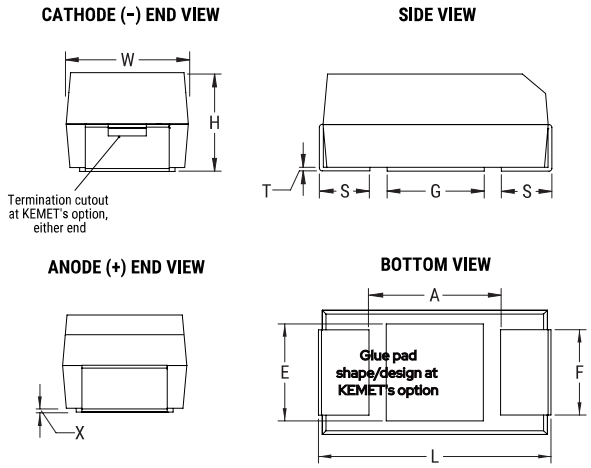
T543L337M2R5ATE025

T543 HRA, Tantalum, Polymer Tantalum, HRA, 330 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Up Screening, N/A, 25 mOhms, 1.9 mm, 2312 / 6032



Click here for the 3D model.

General Information	
Series	T543 HRA
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, Up Screening
Features	Non-Combustible, Low Profile, Low ESR, High Reliability
RoHS	Yes
Termination	Tin
Shelf Life	52 Weeks
MSL	3

Dimensions	
L	6mm +/-0.3mm
W	3.2mm +/-0.3mm
H	1.8mm +/-0.1mm
T	0.13mm REF
S	1.3mm +/-0.3mm
F	2.2mm +/-0.1mm
A	3.1mm MIN
E	2.4mm REF
G	2.8mm REF
X	0.05mm REF

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	1000

Specifications	
Capacitance	330 uF
Tolerance	20%
Voltage DC	2.5 VDC (105C)
Temperature Range	-55/+105°C
Rated Temperature	105°C
Humidity	60C, 90% RH, 500 Hours
Dissipation Factor	8% 120Hz 25C
Failure Rate	N/A
ESR	25 mOhms (100kHz)
Ripple Current	2449 mA (rms, 100kHz 45C)
Leakage Current	82.5 uA (5min 25°C)
Testing and Reliability	Standard Testing Only

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

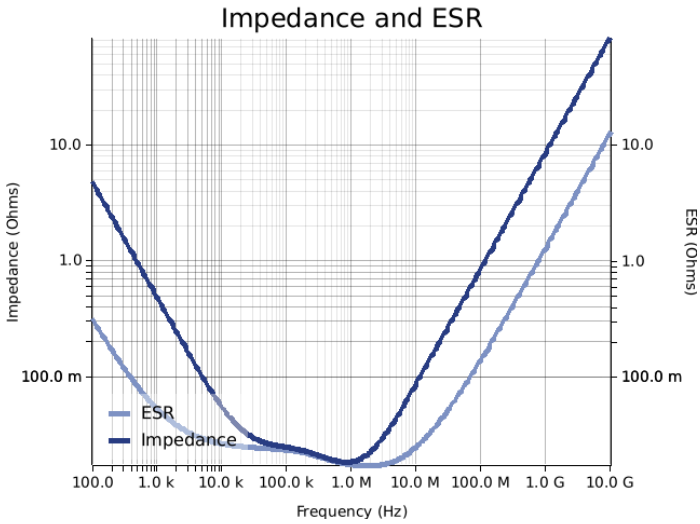
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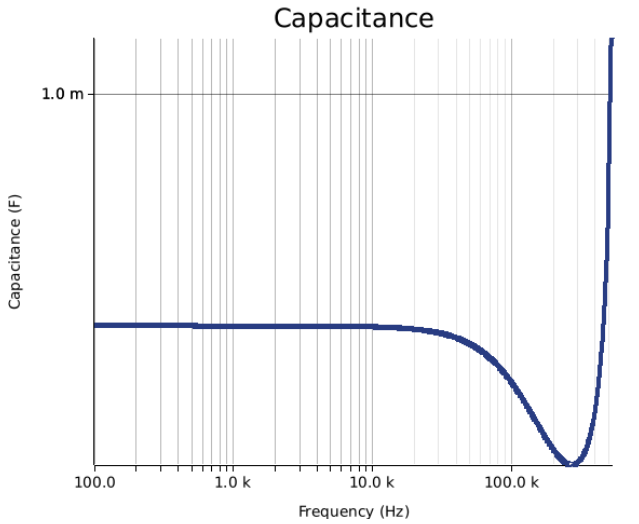
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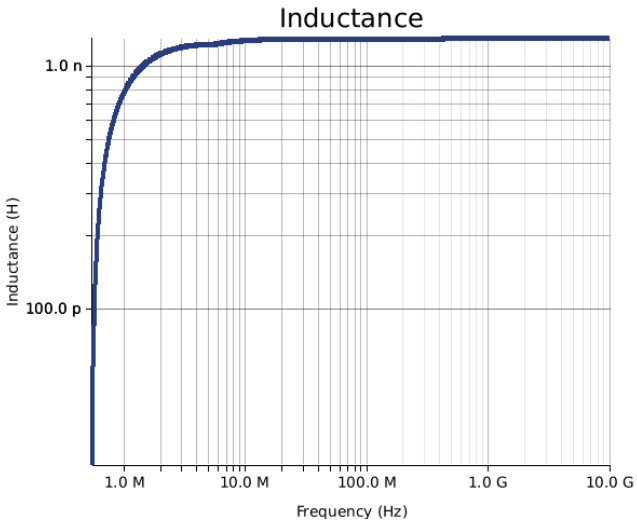
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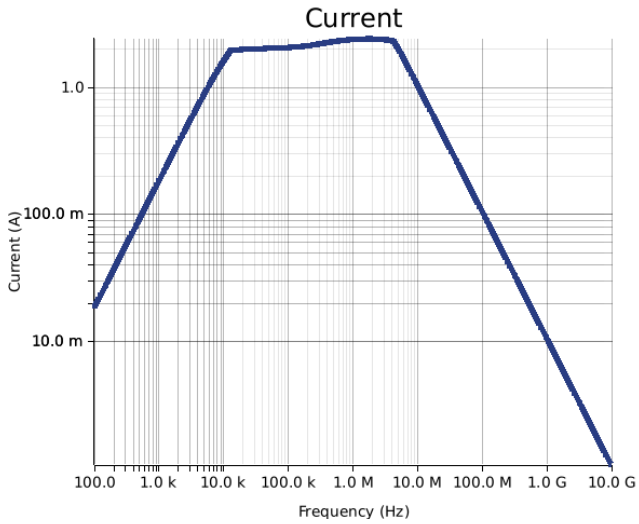
Simulations

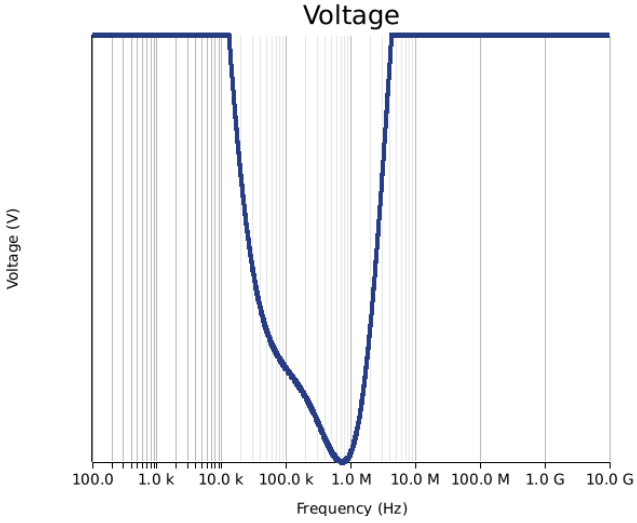
For the complete simulation environment please visit Y-SIM.

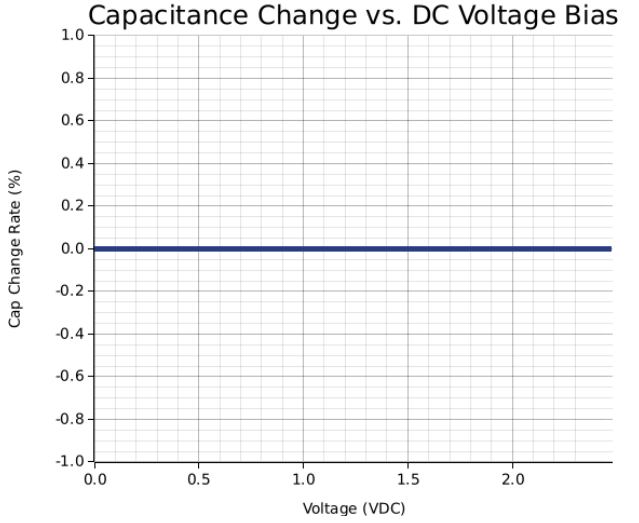








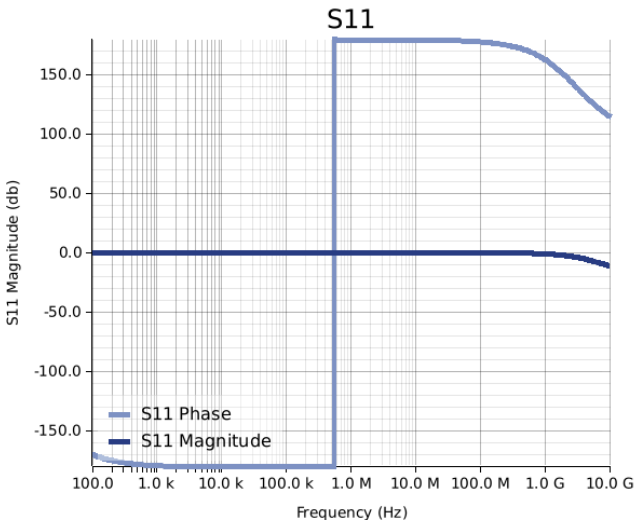


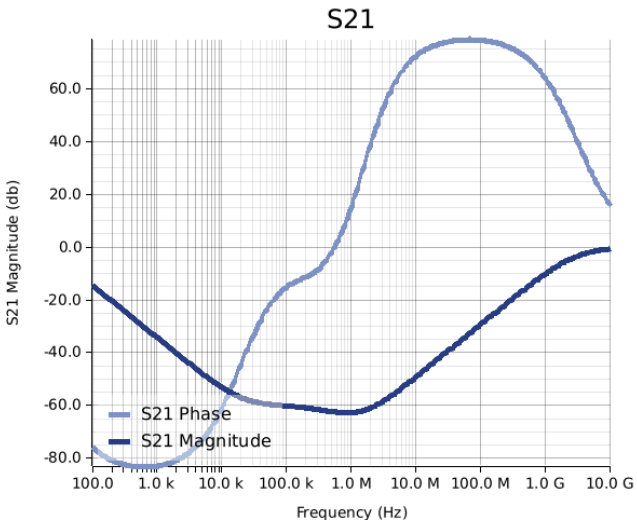


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These are simulations.
This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple “Ripple Current/Voltage vs. Frequency” plots is the ESR at ambient temperature.
- The ESR in the “Temperature Rise vs. Ripple Current” plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
- The peak voltages generated in the “Temperature Rise vs. Combined Ripple Currents” plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the “Information”) are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.

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